



Additional Information







Resources

Accessories

Samples

■ High in

High interrupting rating -1500A @ 75Vdc

100A ratings

Available in 70A, 80A, and

current events in the application.

Description

- With faster opening time response
- Surface mountable high current fuse
- Robust and solderless fuse design
- Lead-free, Halogen-free, and RoHS compliant
- UL Recognized to UL/CSA/NMX 248-1

Features & Benefits

This high-current SMD fuse is a small, square, surface mount fuse that is designed as supplemental overcurrent protection for high-current circuits in various applications. This faster opening version enhances protection of the product from overload and short circuit

- Single fuse solution for high current applications
- Suitable for a wide variety of voltage requirement and application
- Guaranteed protection against overload and short circuit current events
- Compatible with high volume assembly requirements
- Enhanced product reliability and performance
- Conforms to IEC/EN 60127-1 and IEC/EN 60127-7

Agency Approvals

Agency	Agency File Number	Ampere Range
(€	N/A	70A – 100A
UK CA	N/A	70A – 100A
c 71 °us	E71611	70A – 100A
\triangle	J50501628	70A – 100A

Applications

- Blade Servers
- Routers
- High-power Battery Systems
- Power Factor Correction (PFC) in high wattage power supplies
- Power Distribution Units (PDUs)

Electrical Characteristics for Series

% of Ampere Rating	Opening Time
100%	1 Hour, Min.
200%	60 Seconds, Max.

Electrical Specifications by Item

Ampere		Max Voltage	Interrupting	Nominal Cold	Nominal Voltage	Nominal Melting ** I²t (A²sec)	Agency Approvals				
Rating (A)	· Amn Code	Rating (V)	Rating	Resistance (mOhms)	Drop * (mV)		Œ	UK CA	c 71 0°us	A	
70	070.			0.82	89	1050	X	Χ	X	Χ	
80	080.	75Vdc	1500A @75Vdc	0.63	86	2000	X	X	X	Χ	
100	100			0.52	96	4800	X	X	X	Χ	

Thermal Characteristics

Ampere Rating	Typical Case Temperature Rise (°C) *			
I _n (A)	@ 50%I _n	@ 75%I _n	@ 100%I _n	
70	16	38	73	
80	25	58	88	
100	32	60	127	

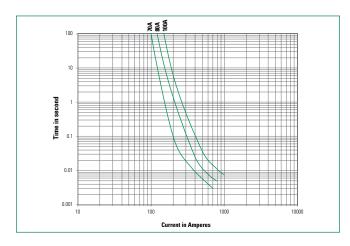
^{*} Typical values based on tests conducted with fuse mounted on FR-4 circuit board of 0.062" (1.6 mm) thickness with 6 oz. (210 µm) Cu.



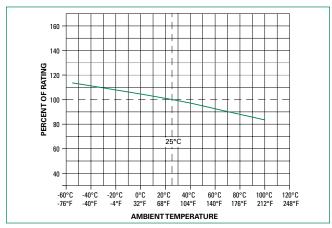
881F Series

High-Current Fast Opening SMD Fuse

Average Time Current Curves



Temperature Re-rating Curve



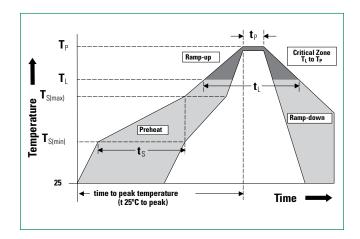
- Note:

 1. Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.
- For continuous operation at 70°C, the fuse should be re-rated as follows:
- | = (0.75)(0.90)|_a = (0.675)_a

 2. The temperature re-rating curve represents nominal conditions. For questions about the temperature rerating curve, please consult Littelfuse technical support assistance.

Soldering Parameters

Reflow Condi	Pb – Free assembly		
Pre Heat	-Temperature Min (T _{s(min)})	150°C	
	-Temperature Max (T _{s(max)})	200°C	
	-Time (Min to Max) (t _s)	60 – 180 secs	
Average ramp	5°C/second max.		
$T_{S(max)}$ to T_L - F	5°C/second max.		
Reflow	-Temperature (T _L) (Liquidus)	217°C	
nellow	-Temperature (t _L)	60 – 150 seconds	
Peak Tempera	260 ^{+0/-5} °C		
Time within 5	Time within 5°C of actual peak Temperature (tp)		
Ramp-down I	5°C/second max.		
Time 25°C to	8 minutes max.		
Do not excee	260°C		

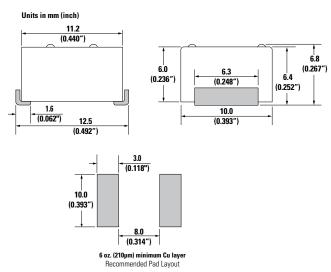




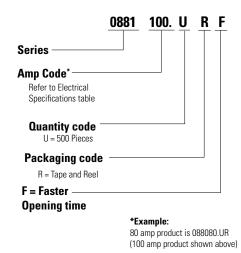
881F Series

High-Current Fast Opening SMD Fuse

Dimensions



Part Numbering System



Product Characteristics

Materials	Body: Thermoplastic, RTI 150°C Terminations: Tin-plated Copper		
Product Marking	Brand logo, Voltage Rating, 'F' (Faster Opening Time), and Ampere Rating		
Operating Temperature 1 2	-55° to +100°C with proper derating		

- Based on loading at 75% of ampere rating when mounted using recommended pad layout.
 Usage outside of stated operating temperature range requires testing in application.
- Maintain case temperature below 150°C in application.

	MIL-Std 202 Method 107	
Thermal Shock	Test Condition B (-65°C to 125°C, 5	
	cycles).	
Moisture Resistance	MIL-Std 202 method 106	
Moisture nesistance	High Humidity (90-98%RH), Heat (65°C)	
Vibration	MIL-STD-202, Method 201 (10-55 Hz)	
	MIL-STD-202, Method 213,	
Mechanical Shock	Test Condition I	
	(100 G's peak for 6 milliseconds)	
Resistance to Solder Heat	MIL-Std 202 Method 210	
nesistance to Solder neat	Test Condition B (10sec at 260°C)	
Solderability	MIL-STD-202 Method 208	
MSL Test	Level 2a J-STD-020	
	MIL-Std 202 Method 101	
Salt Fog	Test Condition B (5% NaCL solution,	
	48 hours exposure)	

Packaging

Packaging Option Packaging Specification		Quantity	Quantity & Packaging Code
24mmTape and Reel	EIA-481 Rev. D (IEC 60286-3)	500	UR

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